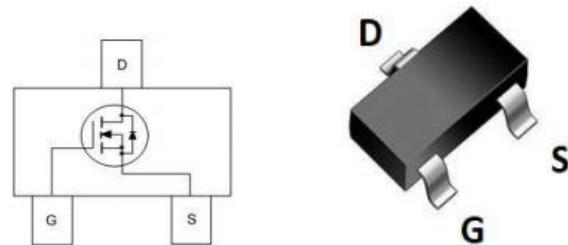


**SOT-23-3L 20V N Channel Enhancement 沟道增强型
MOS Field Effect Transistor 场效应管**

■Absolute Maximum Ratings 最大额定值

Characteristic 特性参数	Symbol 符号	Rating 额定值	Unit 单位
Drain-Source Voltage 漏极-源极电压	BV_{DSS}	20	V
Gate- Source Voltage 栅极-源极电压	V_{GS}	± 12	V
Drain Current (continuous)漏极电流-连续	I_D (at $T_A = 25^\circ C$)	12	A
Drain Current (pulsed)漏极电流-脉冲	I_{DM}	25	A
Total Device Dissipation 总耗散功率	P_D (at $T_A = 25^\circ C$)	1500	mW
Thermal Resistance Junction-Ambient 热阻	$R_{\theta JA}$	83.3	$^\circ C/W$
Junction/Storage Temperature 结温/储存温度	T_J, T_{stg}	-55~150	$^\circ C$

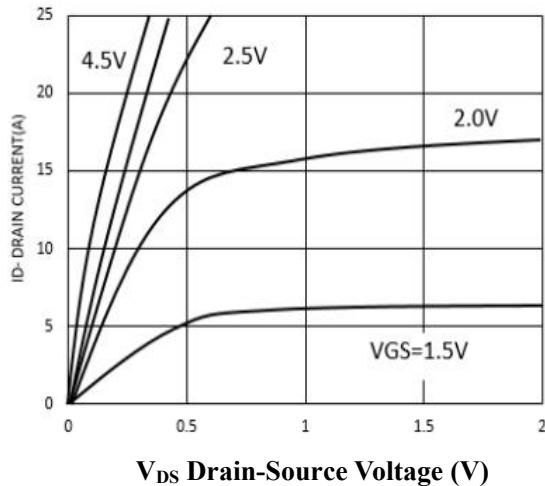
■Device Marking 产品字标

FS12N02=12N02

■ Electrical Characteristics 电特性(T_A=25°C unless otherwise noted 如无特殊说明, 温度为 25°C)

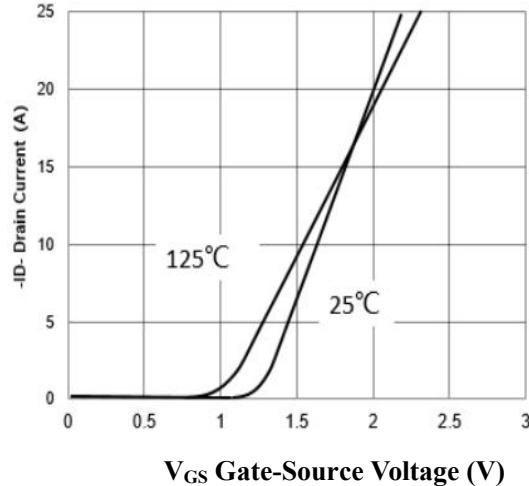
Characteristic 特性参数	Symbol 符号	Min 最小值	Typ 典型值	Max 最大值	Unit 单位
Drain-Source Breakdown Voltage 漏极-源极击穿电压(I _D = 250uA, V _{GS} =0V)	BV _{DSS}	20	—	—	V
Gate Threshold Voltage 栅极开启电压(I _D = 250uA, V _{GS} = V _{DS})	V _{GS(th)}	0.4	0.7	1.0	V
Zero Gate Voltage Drain Current 零栅压漏极电流(V _{GS} =0V, V _{DS} = 20V)	I _{DSS}	—	—	1	uA
Gate Body Leakage 栅极漏电流(V _{GS} =±12V, V _{DS} =0V)	I _{GSS}	—	—	±100	nA
Static Drain-Source On-State Resistance 静态漏源导通电阻(I _D =12A, V _{GS} = 4.5V) (I _D = 7A, V _{GS} = 2.5V)	R _{DSS(ON)}	—	6 7	8 9	mΩ
Diode Forward Voltage Drop 内附二极管正向压降(I _{SD} = 12A, V _{GS} =0V)	V _{SD}	—	—	1.2	V
Input Capacitance 输入电容 (V _{GS} =0V, V _{DS} = 10V,f=1MHz)	C _{ISS}	—	1650	—	pF
Common Source Output Capacitance 共源输出电容(V _{GS} =0V, V _{DS} = 10V,f=1MHz)	C _{OSS}	—	266	—	pF
Reverse Transfer Capacitance 反馈电容 (V _{GS} =0V, V _{DS} = 10V,f=1MHz)	C _{rss}	—	206	—	pF
Total Gate Charge 栅极电荷密度 (V _{DS} = 10V, I _D = 4A, V _{GS} = 4.5V)	Q _g	—	50	—	nC
Gate Source Charge 栅源电荷密度 (V _{DS} = 10V, I _D = 4A, V _{GS} = 4.5V)	Q _{gs}	—	5	—	nC
Gate Drain Charge 栅漏电荷密度 (V _{DS} = 10V, I _D = 4A, V _{GS} = 4.5V)	Q _{gd}	—	8	—	nC
Turn-ON Delay Time 开启延迟时间 (V _{DS} = 10V I _D = 4A, R _{GEN} =3 Ω ,V _{GS} = 4.5V)	t _{d(on)}	—	13	—	ns
Turn-ON Rise Time 开启上升时间 (V _{DS} = 10V I _D = 4A, R _{GEN} =3 Ω ,V _{GS} = 4.5V)	t _r	—	110	—	ns
Turn-OFF Delay Time 关断延迟时间 (V _{DS} = 10V I _D = 4A, R _{GEN} =3 Ω ,V _{GS} = 4.5V)	t _{d(off)}	—	40	—	ns
Turn-OFF Fall Time 关断下降时间 (V _{DS} = 10V I _D = 4A, R _{GEN} =3 Ω ,V _{GS} = 4.5V)	t _f	—	105	—	ns

■Typical Characteristic Curve 典型特性曲线



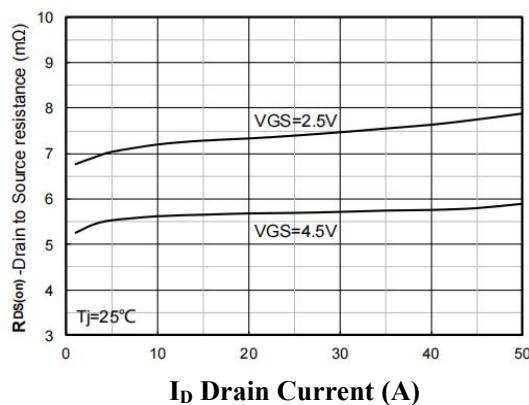
V_{DS} Drain-Source Voltage (V)

Figure 1: Output Characteristics



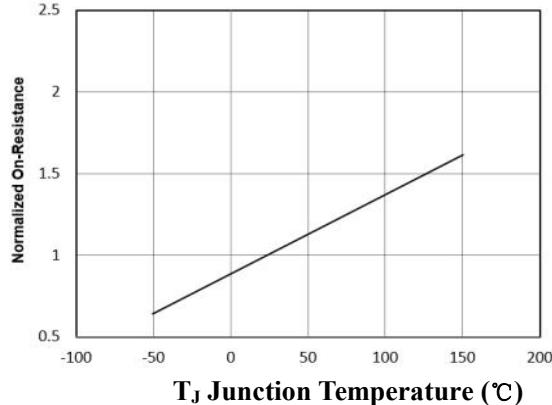
V_{GS} Gate-Source Voltage (V)

Figure 2: Transfer Characteristics



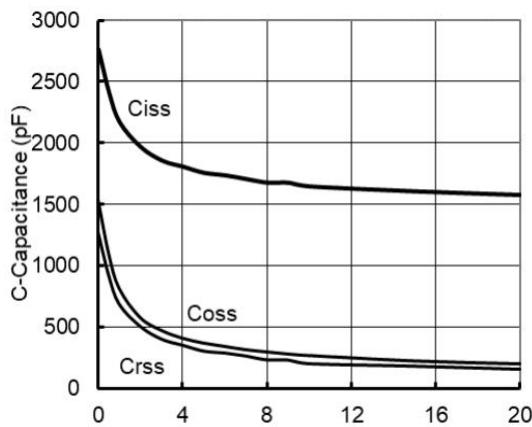
I_D Drain Current (A)

Figure 3: On-Resistance vs. Drain Current



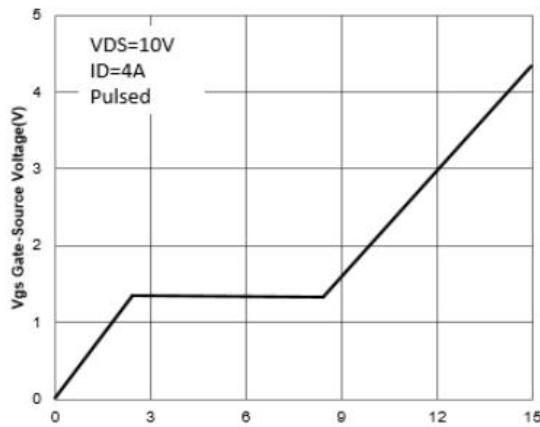
T_J Junction Temperature (°C)

Figure 4: On-Resistance vs. Temperature



V_{DS} Drain-Source Voltage (V)

Figure 5: Capacitance Characteristics



Q_g Gate Charge(nC)

Figure 6: Gate-Charge Characteristics

■Typical Characteristic Curve 典型特性曲线

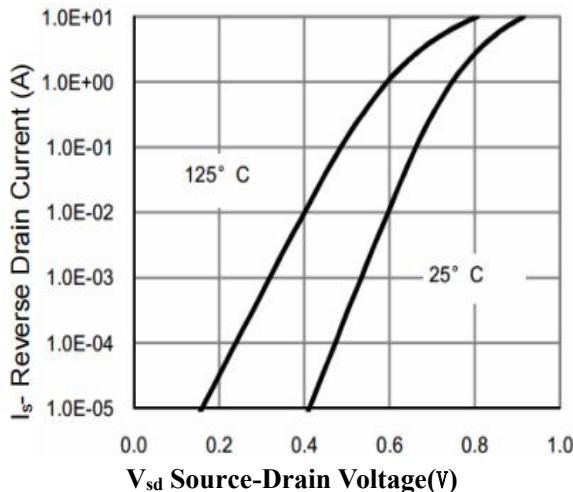


Figure 7: Body Diode Characteristics

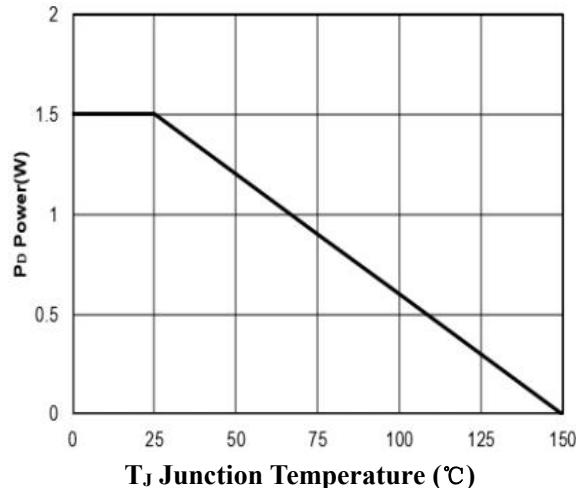


Figure 8: Power Dissipation

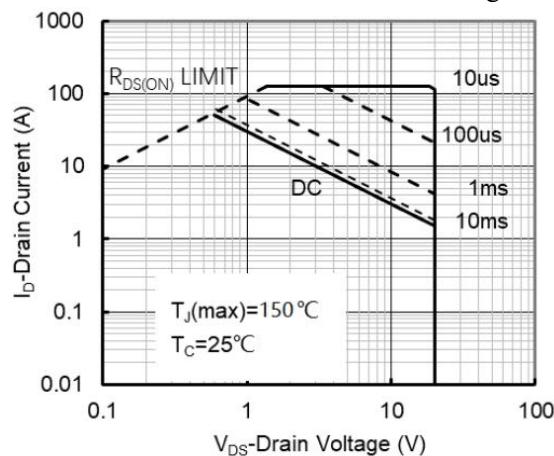


Figure 9: Safe Operating Area

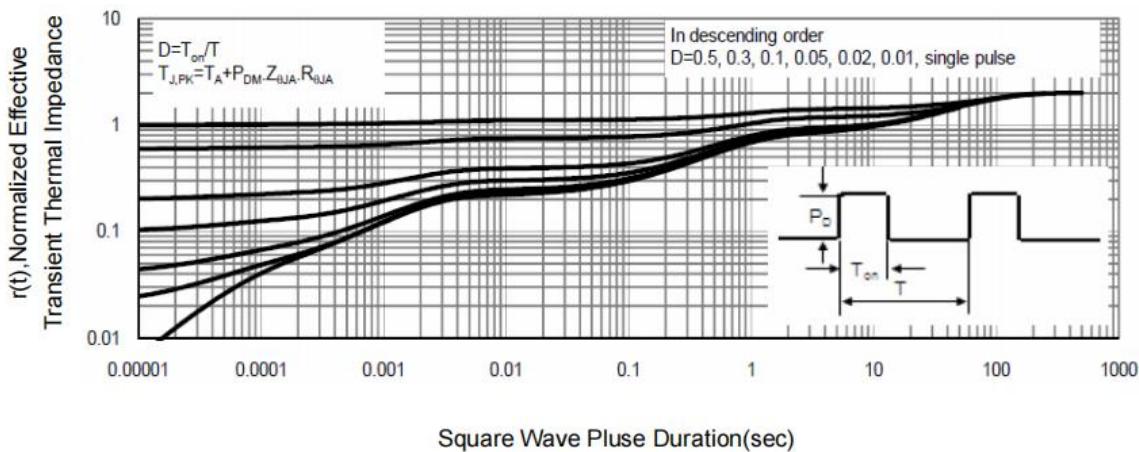
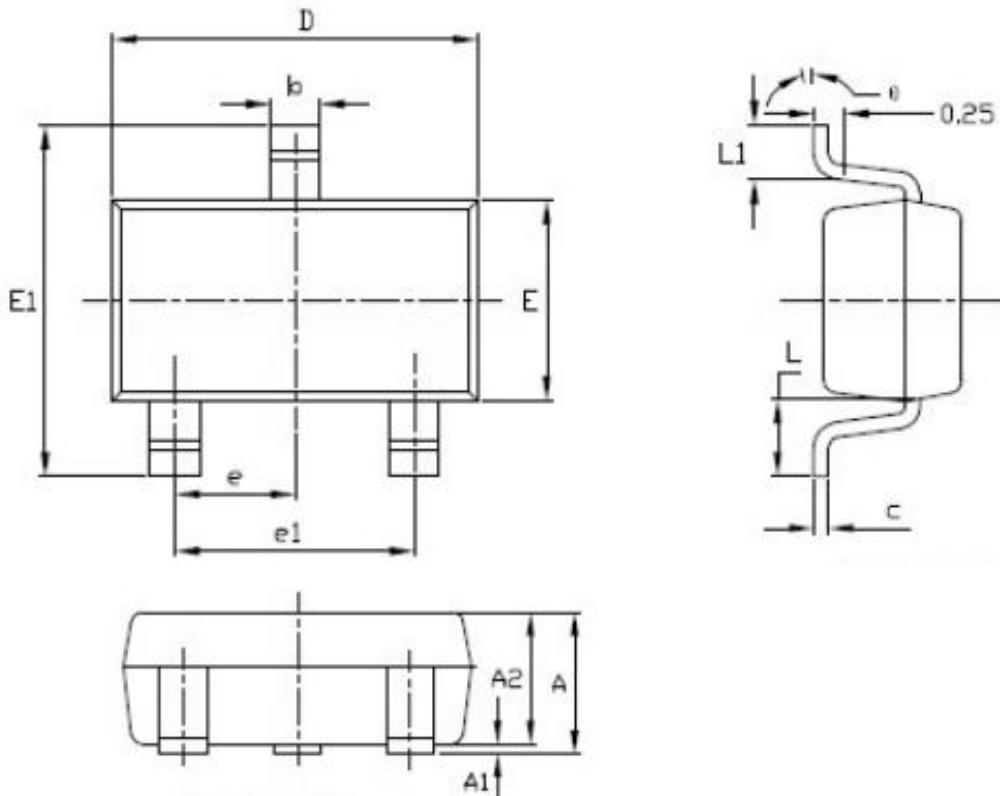


Figure 10: Transient Thermal Response Curve

■ Dimension 外形封装尺寸



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.900	1.00	0.035	0.039
e1	1.800	2.000	0.071	0.079
L	0.450	0.650	0.018	0.026
L1	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°